

EPG.1B.308.HLN

SUMMARY

Wires

Low voltage

8

		(0) (0) (0) (0) (0) (0) (0) (0) (0) (0)
110	114.00	

Image is for illustrative purpose only

Series	1B	Download
Termination type	Female print PCB	Request a quote
IP rating	50	PCB Eagle Pattern
AWG wire size	0.00 - 0.00	PCB Altium Pattern
Cable Ø	0.00 - 0.00 mm	PCB KiCad Pattern
Status	active	Catalog
Matching parts	FGG.1B.308.CLAD62Z	

TECHNICAL DETAILS

Mechanics

Shell Style/Model	EP*: Elbow receptacle for printed circuit (solder or screw fixing)
Keying	1 key (alpha=0, plug: male contacts, receptacle: female contacts)
Housing Material	PPS (Polyphenylene) shell, other pieces nickel plated [SAE AMS QQ N 290] brass
Weight	12.33 g

Performance

Configuration	1B.308/EPG: 8 Low Voltage
Insulator	L: PEEK (UL 94 / V-0/1.5)
Rated Current	2 Amps

Specifications

Contact Type: Print (straight) Contact Dia.: 0.7 mm (0.028in) R (max): 6.1 mOhm Test voltage contact-contact : 1.3 kV rms Test voltage contact-body shell : 1.3 kV rms

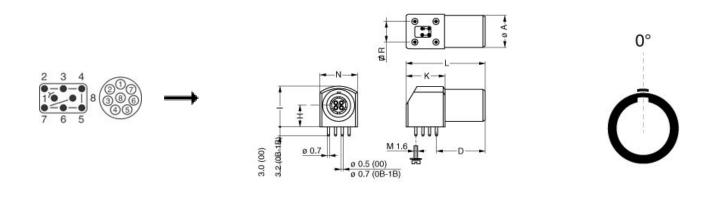
Others

Endurance (Shell): 5000

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Temp (min / max): -55°C / +250°C Humidity (max): <=95% [at 60 deg C /140 F] Vibration: 15 g [10 Hz - 2000 Hz] Shock Resistance: 100 g [6 ms] Climatical Category: 50/175/21 Shielding (min): 75 dB (10 MHz) Shielding (min): 40 dB (1 GHz) Salt Spray Corrosion: >144 hr

DRAWINGS



Dimensions

	А	D	Н	I	к	L	N	R
mm.	11	16.6	7.5	14	13.3	27	12.6	7.62
in.	0,43	0,65	0,30	0,55	0,52	1,06	0,50	0,30

RECOMMENDED BY LEMO

Tools

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